

QEN07

3.2 x 2.5 mm, SMD



Frequency and Electrical Characteristics

Parameter	Min.	Тур.		Max.	Unit	Test condition / Description		ion
Nominal frequency ¹ (Fn)	0.25			125	MHz			
Operating temperature range		-10 to	+70	-55 to +125	°C	See 'Order Part Example'		
Frequency stability over temperature ²				±25 to ±100	ppm	Referenced to frequency reading at 25° and the specified load capacitance		Ū
Storage temperature range	-55			+125	°C			
Long-term stability (Ageing)				±3	ppm	Frequency drift over 1 year at 25°C		r at 25°C
Power supply voltage(V _{CC}) 1.8V (N option 2.5V (M option) 3.3V (D option) 5.0V (A option)	2.375 3.135	1.8 2.5 3.3 5.0		1.890 2.625 3.465 5.250	V _{DC}	See 'Order Part Example'		
HCMOS output load				15	pF			
Output logic levels Output logic high (V _{OH}) Output logic low (V _{OL})	90%Vcc			10%Vcc	V _{DC}	With 15pF HCMOS load		
Duty cycle ³	40	50	60 % See 'Order Part Example		art Example'			
Rise & fall time			7 ns 10% VCC ~ 90% VCC					
Start-up time				5	ms			
Input current	Load capacitance C _L = 15 pF		25.00 40.00	ency to 24.999MHz to 39.999MHz to 59.999MHz to 125.00MHz	V _{CC} = 5V 15 mA 20 mA 30 mA 50 mA	V _{CC} = 3.3V 10mA 15 mA 20 mA 40 mA	V _{CC} = 2.5V 6 mA 8 mA 12 mA 30 mA	V _{CC} = 1.8V 4 mA 6 mA 10 mA 25 mA

Order Part Example - QEN07BDAR / 50.000MHZ

Parameter	Product family and package	Frequency stability (FvT)	Supply Voltage (Vcc)	Output	Output Symmetry	Nominal Frequency (Fn. MHz)
Code	QEN07	В	D	Α	R	50.000MHZ
Decode	QEN = XO 07 = SMD, 3.2x2.5 mm	A = ±100ppm vs -10 to +70°C B = ±50ppm vs -10 to +70°C C = ±25ppm vs -10 to +70°C D = ±100ppm vs -40 to +85°C F = ±50ppm vs -40 to +85°C G = ±25ppm vs -40 to +85°C J = ±100ppm vs -55 to +125°C K = ±50ppm vs -55 to +125°C	A = 5.0V D = 3.3V M = 2.5V N = 1.8V	A = HCMOS, 15pF	Blank = 40/60% R = 45/55%	Please enter Fn

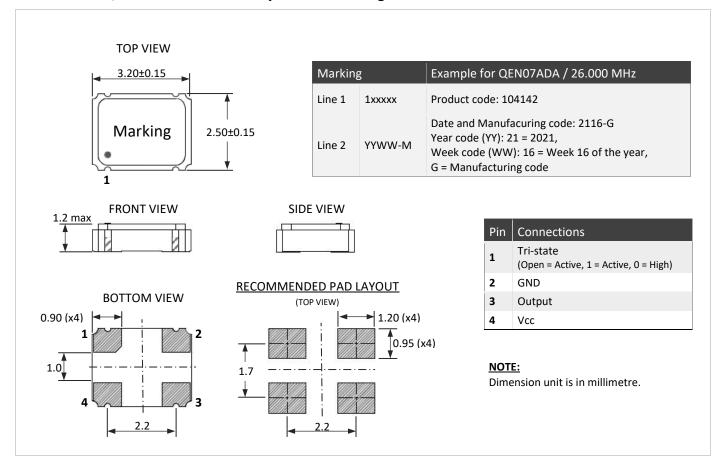
 $^{^{\}rm 1}$ For 5V version, maximum frequency is 54MHz only.

² Include 25°C tolerance, operating temperature range, input voltage change (Vcc ±5%), load change (15pF ±10%), first year ageing, shock and vibration.

³ Duty cycle 45/55% is available on option



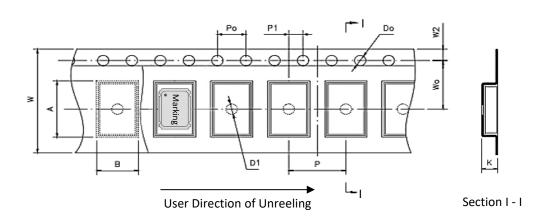
Model Outline, Recommended Pad Layout and Marking





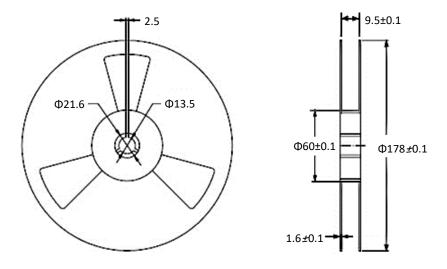
Packaging

TAPRE DETAILS:



Parameter	Code	Dimension	Tolerance
Pitch of components	Р	4.0	± 0.1
Pitch of sprocket hole	P ₀	4.0	± 0.1
Length from hole center to component center	P ₁	2.0	± 0.1
Width of carrier tape	W	8.0	±0.3
Width of adhesive tape	W_0	3.5	± 0.1
Height of component pocket	Α	3.5	± 0.1
Width of component pocket	В	2.7	± 0.1
Gap of hold down tape and carrier tape	W ₂	1.75	± 0.1
Diameter of sprocket hole	D ₀	Ф 1.5	± 0.05
Diameter of feed hole	D_1	Ф 1.5	± 0.25
Total of tape thickness	K	1.3	± 0.1

REEL DETAILS



NOTE:

- Standard Packing Quantity (SPQ): 3000 pcs/reel
- Unit: mm



Reflow soldering Profile

